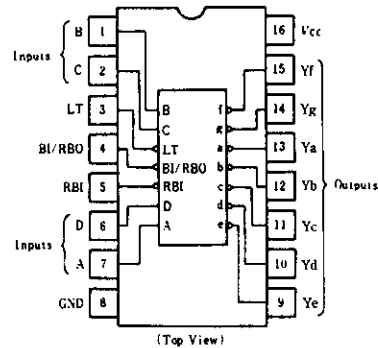


HD74LS47

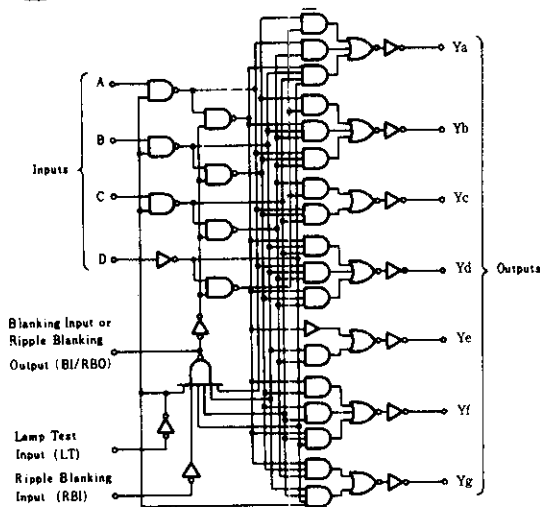
BCD-to-Seven-Segment Decoder/Driver (with 15V Outputs)

HD74LS47 features active-low outputs designed for driving incandescent indicators directly. This device has full ripple-blanking input/output controls and a lamp test input. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions. This circuit incorporates automatic leading and/or trailing-edge zero-blanking control (RBI and RBO). Lamp test (LT) of these types may be performed at any time when the BI/RBO node is at a high level. It contains an overriding blanking input (BI) which can be used to control the lamp intensity of pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL or DTL logic outputs.

PIN ARRANGEMENT



BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Supply voltage	V_{CC}	7.0	V
Input voltage	V_{IN}	7.0	V
Output current ($I_W \leq 1\text{ms, duty cycle} \leq 10\%$)	$I_{O(\text{peak})}$	200	mA
Output current (off-state)	$I_{O(\text{off})}$	1	mA
Operating temperature range	T_{opr}	-20 ~ +75	°C
Storage temperature range	T_{stg}	-65 ~ +150	°C

HD74LS47

FUNCTION TABLE

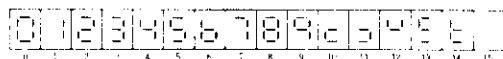
Decimal or Function	Inputs							BI/RBO	Outputs							Note
	LT	RBI	D	C	B	A	a		b	c	d	e	f	g		
0	H	H	L	L	L	L	H	ON	ON	ON	ON	ON	ON	OFF		
1	H	X	L	L	L	H	H	OFF	ON	ON	OFF	OFF	OFF	OFF		
2	H	X	L	L	H	L	H	ON	ON	OFF	ON	ON	OFF	ON		
3	H	X	L	L	H	H	H	ON	ON	ON	ON	OFF	OFF	ON		
4	H	X	L	H	L	L	H	OFF	ON	ON	OFF	OFF	ON	ON		
5	H	X	L	H	L	H	H	ON	OFF	ON	ON	OFF	ON	ON		
6	H	X	L	H	H	L	H	OFF	OFF	ON	ON	ON	ON	ON		
7	H	X	L	H	H	H	H	ON	ON	ON	OFF	OFF	OFF	OFF		
8	H	X	H	L	L	L	H	ON	ON	ON	ON	ON	ON	ON	1	
9	H	X	H	L	L	H	H	ON	ON	ON	OFF	OFF	ON	ON		
10	H	X	H	L	H	L	H	OFF	OFF	OFF	ON	ON	OFF	ON		
11	H	X	H	L	H	H	H	OFF	OFF	ON	ON	OFF	OFF	ON		
12	H	X	H	H	L	L	H	OFF	ON	OFF	OFF	OFF	ON	ON		
13	H	X	H	H	L	H	H	ON	OFF	OFF	ON	OFF	ON	ON		
14	H	X	H	H	H	L	H	OFF	OFF	OFF	ON	ON	ON	ON		
15	H	X	H	H	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF		
BI	X	X	X	X	X	X	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2	
RBI	H	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3	
LT	L	X	X	X	X	X	H	ON	ON	ON	ON	ON	ON	ON	4	

H; high level, L; low level, X; irrelevant

- Notes:
1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.
 2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are off regardless of the level of any other input.
 3. When ripple-blanking input (RBI) and inputs A, B, C, and D are a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output (RBO) goes

to a low level (response condition).

4. When a blanking input/ripple blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.



RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply voltage	V_{CC}	4.75	5.0	5.25	V
Off-state output voltage *	$V_{O(off)}$	—	—	15	V
On-state output current *	$I_{O(on)}$	—	—	24	mA
High level output current **	I_{OH}	—	—	50	μ A
Low level output current **	I_{OL}	—	—	3.2	mA
Operating temperature range	T_{opr}	-20	25	75	$^{\circ}$ C

* Applied to the a through g outputs.

** BI/RBO terminal.

ELECTRICAL CHARACTERISTICS ($T_a = -20 \sim +75^\circ\text{C}$)

Item	Symbol	Test Conditions	min	typ*	max	Unit	
Input voltage	V_{IH}		2.0	—	—	V	
	V_{IL}		—	—	0.8	V	
Output voltage	BI/RBO	V_{OH}	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}, I_{OH}=-50\mu\text{A}$	2.4	—	—	V
		V_{OL}	$V_{CC}=4.75\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}$	—	—	0.4	V
	a ~ g	$V_{O(a)}$	$V_{CC}=5.25\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}$	—	—	0.4	V
		$V_{O(g)}$	$V_{CC}=5.25\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}$	—	—	0.5	V
Output current	a ~ g	$I_{O(a)}$	$V_{CC}=5.25\text{V}, V_{IH}=2\text{V}, V_{IL}=0.8\text{V}, V_{O(a)}$	—	—	250	μA
Input current		I_{IH}	$V_{CC}=5.25\text{V}, V_I=2.7\text{V}$	—	—	20	μA
	All input except BI/RBO	I_{IL}	$V_{CC}=5.25\text{V}, V_I=0.4\text{V}$	—	—	-0.4	mA
	BI/RBO			—	—	-1.2	mA
		I_I	$V_{CC}=5.25\text{V}, V_I=7\text{V}$	—	—	0.1	mA
Short-circuit output current	BI/RBO	I_{OS}	$V_{CC}=5.25\text{V}$	-0.3	—	-2	mA
Supply current **		I_{CC}	$V_{CC}=5.25\text{V}$	—	7	13	mA
Input clamp voltage		V_{IK}	$V_{CC}=4.75\text{V}, I_{IN}=-18\text{mA}$	—	—	-1.5	V

* $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$

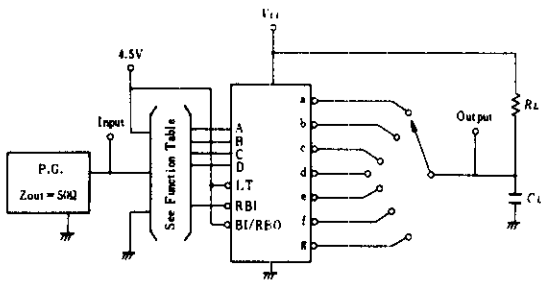
** I_{CC} is measured with all outputs open and all inputs at 4.5V.

SWITCHING CHARACTERISTICS ($V_{CC}=5\text{V}, T_a=25^\circ\text{C}$)

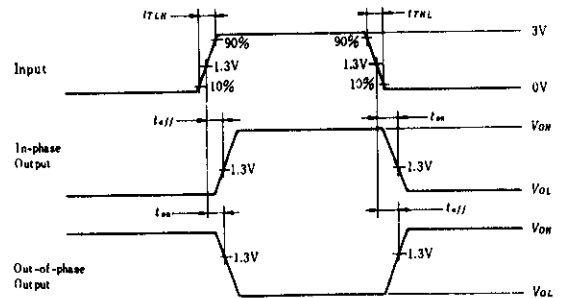
Item	Symbol	Input	Test Conditions	min	typ	max	Unit
Turn-on time	t_{on}	A	$C_L=15\text{pF}, R_L=665\Omega$	—	—	100	ns
		RBI		—	—	100	ns
Turn-off time	t_{off}	A		—	—	100	ns
		RBI		—	—	100	ns

TESTING METHOD

1) Test Circuit



Waveform



2) Testing Table

Item	Inputs					Outputs						
	RBI	D	C	B	A	a	b	c	d	e	f	g
t_{on}	4.5V	GND	GND	GND	IN	OUT	—	—	OUT	OUT	OUT	—
	4.5V	GND	GND	4.5V	IN	—	—	OUT	—	OUT	—	—
t_{off}	4.5V	GND	4.5V	4.5V	IN	OUT	OUT	—	OUT	OUT	OUT	OUT
	IN	GND	GND	GND	GND	OUT	OUT	OUT	OUT	OUT	OUT	—

Input pulse; $t_{TLH} \leq 15\text{ns}, t_{THL} \leq 6\text{ns}, PRR=1\text{MHz},$
duty cycle 50%.

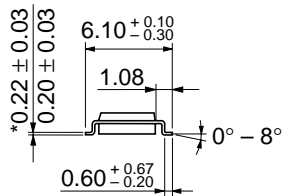
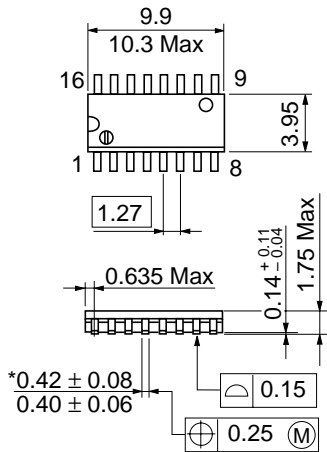


Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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